

Agenda



High Performance Spaceflight Computing (HPSC) Overview

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- HPSC Chiplet Architecture
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Middleware Overview

- Middleware Project Overview
- Middleware Architecture
- Middleware Schedule/Milestones

Middleware Release 2

- Middleware Release 2 Overview
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- Core Flight System (cFS) Mission Use Case

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- Middleware Release 3
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High Performance Spaceflight Computing (HPSC) Overview



HPSC Program Goals

- Dramatically advance the state of the art for spaceflight computing
- HPSC will provide a nearly two orders-of-magnitude improvement above the current state of the art for radiation hardened spaceflight processors, while also providing an unprecedented flexibility to tailor performance, power consumption, and fault tolerance to meet widely varying mission needs
- These advancements will provide game changing improvements in computing performance, power efficiency, and flexibility, which will significantly improve the onboard processing capabilities of future NASA and Air Force space missions

HPSC Program Funding/Management

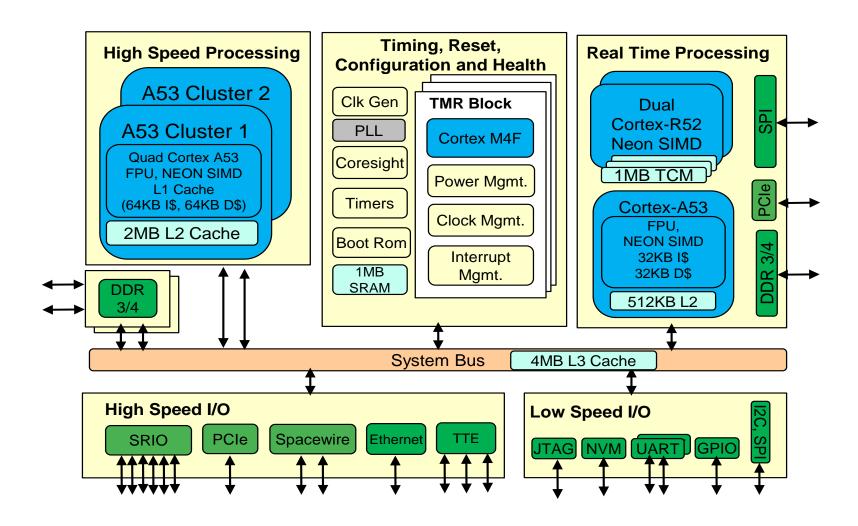
- HPSC is **funded** by NASA's Space Technology Mission Directorate (STMD), Science Mission Directorate (SMD), and the United States Air Force
- The HPSC project is managed by Jet Propulsion Laboratory (JPL), and the HPSC contract is managed by NASA Goddard Space Flight Center (GSFC)

HPSC Program Deliverables

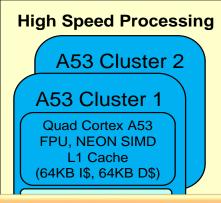
Under the base contract, Boeing will provide:

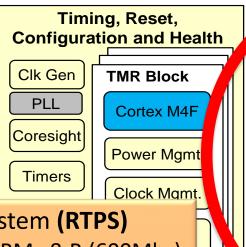
- Prototype radiation hardened multi-core computing processors (Chiplets), both as bare die and as packaged parts
- Prototype system software which will operate on the Chiplets
- Evaluation boards to allow Chiplet test and characterization
- Chiplet emulators to enable early software development





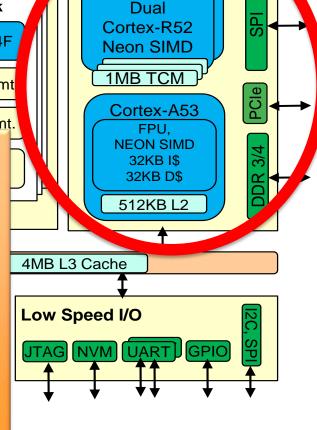






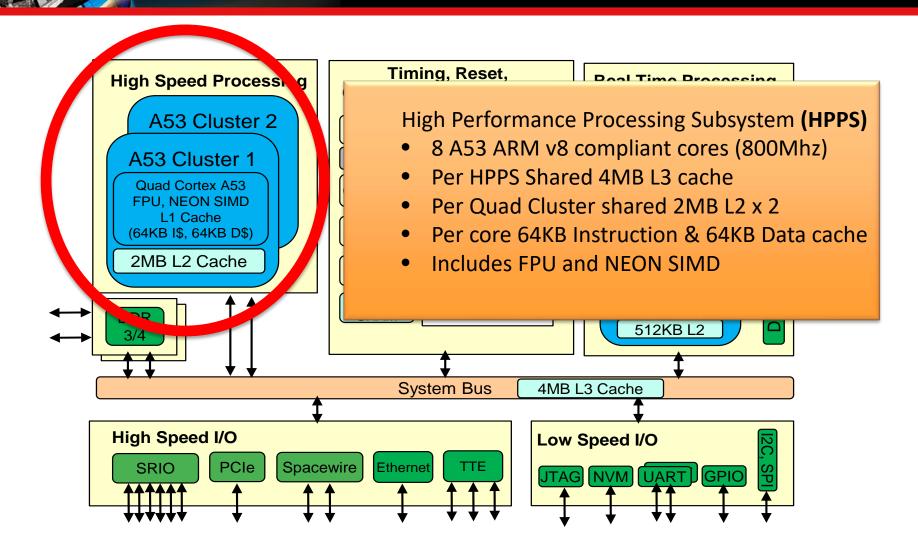
Real Time Processing Subsystem (RTPS)

- SMP or Dual lockstep R52 ARM v8-R (600Mhz)
 - Three 1MB Tightly Coupled Memories (TCM)
 - FPU and NEON SIMD
- Single A53 ARM v8 compliant core(600Mhz)
 - A53 w/512KB Level 2, 32KB Instruction & 32KB Data cache
 - FPU and NEON SIMD
- Separate PCIe and DDR3/DDR4 interfaces

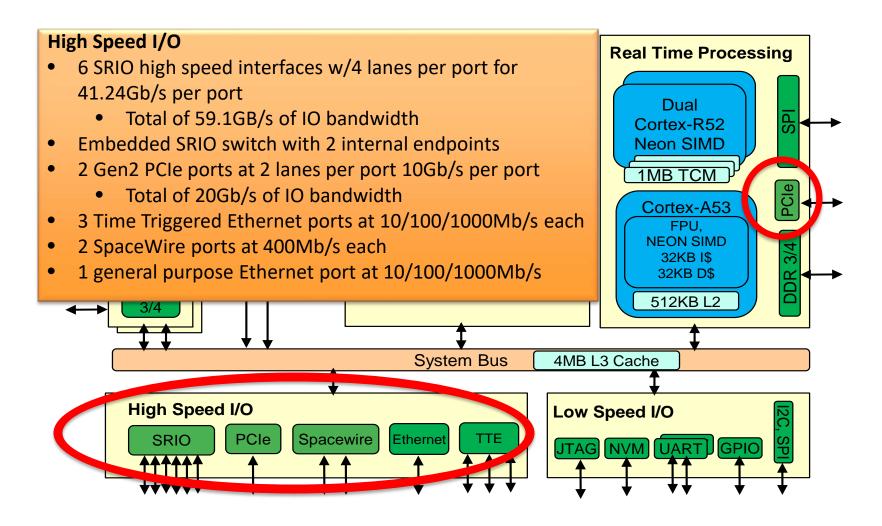


real Time Processing









HPSC Software Architecture



Layered Architecture

- Provides separation of concerns with well-defined interfaces
- Provides application developers with tools, abstractions and methodologies to make use of lower level HPSC SW services and Chiplet HW in a consistent manner

Application Software
Middleware Software
System Software
Chiplet Hardware

Middleware Layer

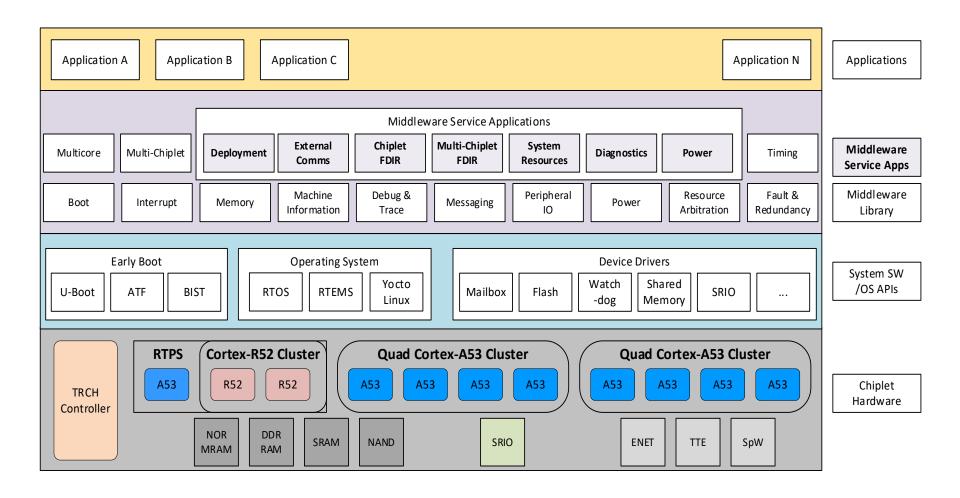
- Allocate and manage processor cores, devices and resources to dynamically trade computational performance, energy management and fault tolerance objectives of the mission
- Provides for mission and platform configurability
- Allows Mission Integration Engineers (MIE) to reason about interactions between applications and the system

System Software Layer

 RTOS/OS, hypervisor and low level device drivers for the Chiplet are provided by HPSC vendor University of Southern California Information Sciences Institute (USC-ISI)

HPSC Software Architecture





System Software Layer



- Provided by vendor USC Information Sciences Institute (USC-ISI)
 - Runtime Components:
 - > Bootloaders:
 - Custom TRCH Bootloader
 - U-boot for RTPS and HPPS
 - > RTOS:
 - ❖ RTEMS for TRCH and RTPS/R52
 - > Linux:
 - Yocto based Linux with KVM hypervisor for HPPS
 - > Chiplet Device drivers
 - ❖ Memory controllers, DMA, peripheral I/O devices, GIC...
 - > Software Build-In System Tests (BIST(s))
 - Memory test, core-cache path, cores, ...
 - > Software-Implemented fault tolerance framework
 - Development Tools:
 - > A software Chiplet emulator: based on QEMU
 - Eclipse-based IDE with advanced performance profiling

Middleware Overview



Middleware Project Information

- A joint project between NASA Jet Propulsion Lab (JPL) and NASA Goddard Space Flight Center (GSFC)
- Funded by the Air Force Research Lab (AFRL)

Middleware Objectives

- Provide applications with an efficient and consistent functions to utilize features of the Chiplet multicore platform for
 - > Resource allocation and management (e.g., cores, memories, peripheral devices)
 - Configuration management
 - Power and Performance management
 - Fault tolerance and redundancy management
 - Sharing hardware resources using a common middleware library and services
 - Messaging Services
- Facilitate deployment of applications for execution with different characteristics and resource needs (e.g., computational needs, mission criticality, timing criticality, ...)

Middleware Architecture



Middleware Service Libraries

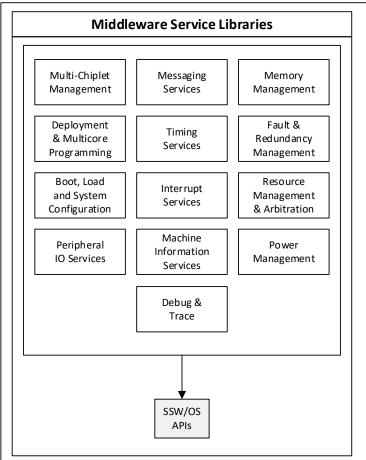
- Middleware service library consists of building block functions with APIs that provide a set of application services.
- MW service library has no runtime thread context on its own.
- MW service library is called in user application context for invoking MW services that interacts with Chiplet devices, RTOS, OS and other services.

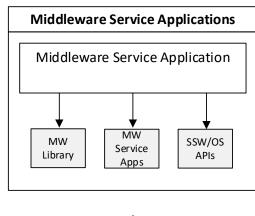
Middleware Service Applications

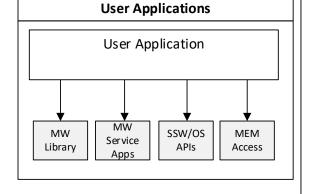
- MW Service Applications provide a set of MW services to meet specific system needs once deployed.
- MW Service Applications are executable programs with runtime context.
 Each service program is configured to a specific deployment need / environment via a user specified configuration file at boot time.

Middleware Service Conceptual Patterns











Middleware Configuration File

- 1) Service app-specific configuration
- 2) Requested resources and mapping
- 3) MW Library service configuration
- 4) SSW/OS API service configuration
- 5) Access to Chiplet-HW configuration



Application Configuration File

- 1) User app-specific configuration
- 2) Requested resources and mapping
- 3) MW Library service configuration
- 4) SSW/OS API service configuration
- 5) Access to Chiplet-HW configuration

Middleware Service Libraries



Service Name	Service Function
Deployment and Multicore Programming	Support different deployment configurations on multi-core systems
Machine Information	Get information about cores, clusters, Chiplets, and system
Resource Management/Arbitration	Manage configuration files and assign available resources to software clients
Memory Management	MMU configuration, memory allocation to applications
Interrupt	Configure Interrupt controller to route interrupts to specific cores at runtime
Timing	Establish, synchronize, and distribute time
Messaging	Send/receive messages between tasks on the same or different cores and Chiplets
Power Management	Power on/off setting for cores/clusters/Chiplets, and set clock rates
Debug and Trace	Support software debugging and performance metrics
Boot and Load Process	Provide an Initial Program Loader (IPL) and support various boot types/processes
Peripheral IO	Allocate and configure Chiplet Peripheral I/O to software clients
Multi-Chiplet Management	Configure and manage Inter-Chiplet interfaces (e.g., boot, messaging, resources)
Fault and Redundancy Management	Fault detection (HW/SW faults) and recovery

Middleware Service Applications

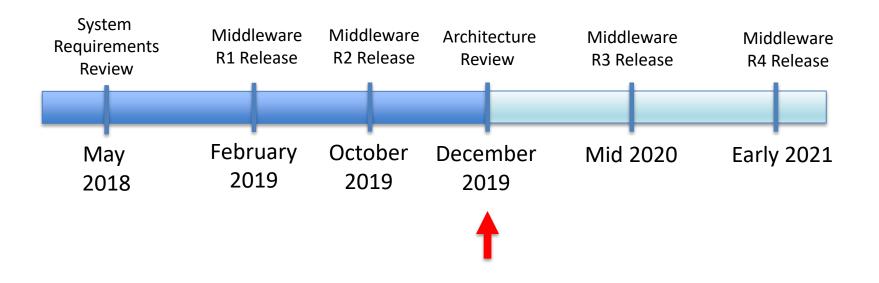


MW Service Application	System-Level Function
Deployment	Set up the system and start applications
Hardware Resource	Arbitrate access to common pool of hardware
Power	Apply power management policy
Diagnostics	Centralize information available in system
Communications	Share access to external communications device
Multiple Chiplet FDIR	Coordinate FDIR activity across chiplets
Single Chiplet FDIR	Coordinate FDIR activity within chiplet



Middleware Schedule / Milestones





Middleware Release 2

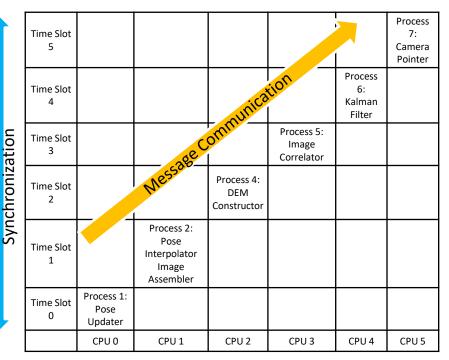


- Middleware Release 2 was completed in October 2019
- Uses the HPSC System Software Release 4 from ISI:
 - RTPS/R52 (AArch32) and HPPS/A53 (AArch64) tool chains
 - QEMU emulation of HPPS and RTPS to support MW testing and demonstration
 - RTEMS in RTPS/R52 and Yocto Linux for HPPS/A53 to run MW applications
 - System software drivers to implement MW use cases (Watchdog Timer (WDT), mailbox, shared memory)
- Built upon the capabilities from R1
 - Implemented Application Programming Interfaces (APIs) for 10 of 13 defined Middleware (MW) service libraries
 - Started implementation on 5 new service libraries
 - > Improved on 5 existing service libraries
 - Not all functions defined for the 10 services are implemented
 - ➤ Not all MW service libraries are ported to R52/RTEMS yet
- Worked on two reference missions using MW functions for execution in QEMU
 - JPL HPFEC application to use additional MW capabilities
 - Ported the GSFC core Flight System (cFS) framework and sample applications to work with MW on HPPS Yocto Linux and RTPS RTEMS

JPL HPFEC Reference Mission



High Performance, Fault-Tolerant Embedded Computing (HPFEC) Synthetic Application



Time

Manage start-up and CPU affinity

This JPL reference mission models elements found in applications for guidance, navigation and control (GNC) of aircraft and spacecraft.

The reference mission is implemented with six processes that use middleware in the following ways:



Manage start-up for processes and set CPU affinity



Synchronize process workloads on time slots



Communicate between processes

GSFC cFS Reference Mission

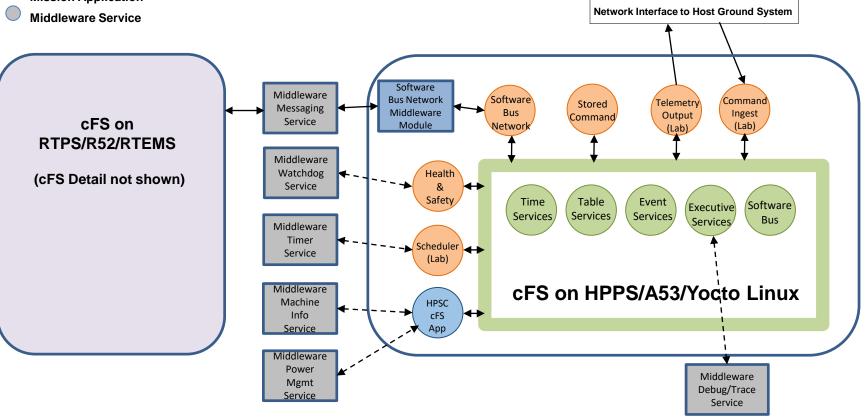


CFE Core Service

cFS Reuse Application

Mission Application

Reduced Set of cFS Applications for initial HPSC Integration and Demo



Middleware Release 3



- Middleware Release 3 planning will be influenced by HPSC Re-plan (Fall 2019)
- Middleware R3 activity will include:
 - Scrub and enhance MW requirements for future releases
 - Specify updated requirements for R3 implementation
 - Design and implement R3 release requirements
 - > Fault Tolerance and Redundancy Service
 - Multi-Chiplet communication, timing & synchronization, boot up and initialization
 - ➤ API for Deployment Configuration
 - ➤ Enhance services from R1, R2
 - Install and exercise delivered capabilities of SSW R5+ releases
 - > RTEMS
 - Eclipse IDE

Middleware Release 4 and Beyond



- Middleware Release 4 work to complete
 - Complete all 13 Middleware Service Libraries
 - Complete all 6 Middleware Service Applications
 - Continue to test and integrate new System Software features
 - Continue refining requirements
 - Improve and complete documentation
- Potential deployment Tools*
 - Application Characteristics Template
 - Configuration Checker
 - Interaction Modeling
 - Schedule Generator
- Potential diagnostic Tools*
 - Improved Event Visualization
 - View Live Statistics
 - Blackbox Recorder

^{*}may depend on schedule and/or additional funding

Acknowledgements



HPSC Middleware Team:

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HPSC Project Team:

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Boeing / ISI:

Jon Ballast/Boeing, J.P. Walters/USC-ISI



Acronyms (1)



Acronym	Meaning	Acronym	Meaning
AFRL	Air Force Research Laboratory	DRAM	Dynamic Random Access Memory
AMBA	Advanced Microcontroller Bus Architecture	FCR	Fault Containment Region
API	Application Programmer Interface	FDIR	Fault Detection, Isolation, and Recovery
ARM	Advanced RISC Machines	FPGA	Field programmable Gate Array
ATF	Arm Trusted Firmware	FPU	Floating Point Unit
BIST	Built In Self Test	GNC	Guidance Navigation and Control
BSP	Board Support Package	GOPS	Giga Operations Per Second
C&DH	Command and Data Handling	GPIO	General Purpose Input Output
cFS	core Flight System	GPU	Graphics Processing Unit
CPU	Central Processing Unit	GSFC	Goddard Space Flight Center
DDR	Double Data Rate	НЕО	Human Exploration and Operations
DMIPS	Dhrystone Millions of Instructions per Second	HPFEC	High Performance Fault-tolerant Embedded Computing
DMR	Dual Modular Redundancy	HPPS	High Performance Processing Subsystem



Acronyms (2)



Acronym	Meaning	Acronym	Meaning
HPSC	High Performance Spacecraft Computing	MIE	Mission Integration Engineer
HW	Hardware	MIPS	Millions of Instructions per Second
1/0	Input / Output	мми	Memory Management Unit
12C	Inter-Integrated Circuit	МРІ	Message Passing Interface
IDE	Integrated Development Environment	MRAM	Magnetoresistive Random Access Memory
IPL	Initial Program Loader	MW	Middleware
ISA	Instruction Set Architecture	NAND	NOT-AND logic
ISI	Information Sciences Institute	NASA	National Aeronautics and Space Administration
ITAR	International Traffic In Arms Regulations	NEON	Single Instruction Multiple Data architecture
JPL	Jet Propulsion Laboratory	NVRAM	Non Volatile Random Access Memory
JTAG	Joint Test Action Group (Debug interface)	PCIe	Peripheral Component Interconnect express
KVM	Kernel Based Virtual Machine	QEMU	Quick Emulator
МВ	Megabyte	R1, R2, R3	Release 1, Release 2, Release 3



Acronyms (3)



Acronym	Meaning	Acronym	Meaning
RTEMS	Real Time Executive for Multiprocessor Systems	sw	Software
RTOS	Real Time Operating System	TBD	To Be Determined
RTPS	Real Time Processing Subsystem	TMR	Triple Modular Redundancy
SCP	Self Checking Pair	TRCH	Timing, Reset, Configuration, and Health
SIMD	Single Instruction Multiple Data	TTE	Time Triggered Ethernet
SMD	Science Mission Directorate	UART	Universal Asynchronous Receiver Transmitter
SPI	Serial Peripheral Interface	USC	University of Southern California
SPW	Spacewire	VMC	Vehicle Management Computer
SRAM	Static Random Access Memory		
SRIO	Serial Rapid Input Output		
SSR	Solid State Recorder		
ssw	System Software		
STMD	Space Technology Mission Directorate		